

# HiPerFET™ Power MOSFETs Single Die MOSFET

IXFN280N085

N-Channel Enhancement Mode Avalanche Rated, High dv/dt, Low t<sub>r</sub>

Symbol	Test Conditions	Maximum F		
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 150°C	85		
V <sub>DGR</sub>	$T_J = 25^{\circ}C$ to 150°C, $R_{GS} = 1M\Omega$	85	V	
$V_{\rm gss}$	Continuous	±20	V	
V <sub>GSM</sub>	Transient	±30	V	
I <sub>D25</sub>	T <sub>C</sub> = 25°C, Chip capability	280	Α	
I <sub>L(RMS)</sub>	External Lead Current Limit	200	Α	
I <sub>DM</sub>	$T_{\rm C} = 25^{\circ}$ C, pulse width limited by $T_{\rm JM}$	1120	A	
I <sub>A</sub>	$T_{c} = 25^{\circ}C$	200	Α	
E <sub>as</sub>	$T_{\rm C} = 25^{\circ}C$	4	J	
dV/dt	$I_{_{S}} \le I_{_{DM}}, V_{_{DD}} \le V_{_{DSS}}, T_{_{J}} \le 150^{\circ}C$	5	V/ns	
P <sub>d</sub>	T <sub>c</sub> = 25°C	700	W	
T		-55 +150	°C	
$\mathbf{T}_{JM}$		150	°C	
T <sub>stg</sub>		-55 +150	°C	
V <sub>ISOL</sub>	50/60 Hz, RMS t = 1min	2500	V~	
	$I_{ISOL} \le 1 \text{mA}$ $t = 1 \text{s}$	3000	V~	
M <sub>d</sub>	Mounting torque Terminal connection torque	1.5/13 1.3/11.5	Nm/lb.in. Nm/lb.in.	
Weight		30	g	

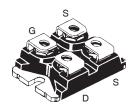
Symbol	Test Conditions	U		values ise specified) Max.		
BV <sub>DSS</sub>	$V_{GS} = 0V, I_D = 3mA$		85		V	
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 8mA$		2.0	4.0	V	
I <sub>GSS</sub>	$V_{GS} = \pm 20V, V_{DS} = 0V$			±200	nA	
I <sub>DSS</sub>	$V_{DS} = V_{DSS}$ $V_{GS} = 0V$	T <sub>J</sub> = 125°C		100 2	μA mA	
R <sub>DS(on)</sub>	$V_{GS} = 10V, I_{D} = 100A, No.$	ote 1		4.4	mΩ	

 $V_{pee} = 85V$ 

 $I_{D25} = 280A$ 

 $R_{_{DS(on)}} \leq 4.4 m\Omega$ 

miniBLOC, SOT-227 B E153432



G = Gate D = DrainS = Source

Either Source terminal at miniBLOC can be used as Main or Kelvin Source

#### **Features**

- International standard package
- miniBLOC, with Aluminium nitride isolation
- $\bullet \ \mathsf{Low} \ \mathsf{R}_{\mathsf{DS}(\mathsf{on})} \ \mathsf{HDMOS^{\mathsf{TM}}} \ \mathsf{process}$
- Rugged polysilicon gate cell structure
- Avalanche rated
- Guaranteed FBSOA
- Low package inductance
- Fast intrinsic Rectifier

### **Advantages**

- · Easy to mount
- Space savings
- High power density

#### **Applications**

- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- Temperature and lighting controls





Symbol	Test Conditions	Cha	naracteristic Values			
$(T_J = 25^{\circ}C, \iota$	unless otherwise specified)	Min.	Тур.	Max.		
g <sub>fs</sub>	$V_{DS} = 10V, I_{D} = 60A, Note 1$	60	100	S		
C <sub>iss</sub>			19	nF		
C <sub>oss</sub>	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		6.4	nF		
C <sub>rss</sub>			3.2	nF		
t <sub>d(on)</sub>	Resistive Switching Times		40	ns		
t, (	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 60A$		150	ns		
t <sub>d(off)</sub>	$R_{\rm G} = 10$ (External)		112	ns		
$t_f$	n <sub>G</sub> = 152 (External)		60	ns		
Q <sub>g(on)</sub>			580	nC		
Q <sub>gs</sub>	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 100A$		77	nC		
$\mathbf{Q}_{gd}$			280	nC		
R <sub>thJC</sub>				0.18 °C/W		
R <sub>thCS</sub>			0.05	°C/W		

miniB	LOC, S	OT-227	В		
T H N N N N N N N N N N N N N N N N N N					
M4 screws (4x) supplied					
Dim.	Millimeter		Inches		
	Min.	Max.	Min.	Max.	
Α	31.50	31.88	1.240	1.255	
В	7.80	8.20	0.307	0.323	
С	4.09	4.29	0.161	0.169	
D	4.09	4.29	0.161	0.169	
E	4.09	4.29	0.161	0.169	
F	14.91	15.11	0.587	0.595	
G	30.12	30.30	1.186	1.193	
H	38.00	38.23	1.496	1.505	

12.22

9.60

0.84

12.85

25.42

2.13

5.97

26.90

4.42

4.85

25.07

0.1

0.460

0.351

0.030

0.496

0.990

0.078

0.195

1.045

0.155

0.186

0.968

-0.002

0.481

0.378

0.033

0.506

1.001

0.084

0.235

1.059 0.174

0.191

0.987

0.004

J K

L M

Ν

0

Р

Q

R

S

T U 11.68

8 92

0.76

12.60

25.15

4.95

26.54

3.94

4.72

24.59

-0.05

## Source-Drain Diode

Symbol Test Conditions			racteristic	c Values	√alues			
$(T_{J} = 25^{\circ}C, t)$	unless otherwise specified)	Min.	Тур.	Max.				
I <sub>s</sub>	$V_{GS} = 0V$			280	Α			
I <sub>SM</sub>	Repetitive, pulse width limited by $T_{_{JM}}$			1120	Α			
V <sub>SD</sub>	I <sub>F</sub> = 100A, V <sub>GS</sub> = 0V, Note 1			1.2	V			
t <sub>rr</sub>				200	ns			
Q <sub>RM</sub>	$I_F = 50A$ , -di/dt = 100A/ $\mu$ s, $V_R = 50V$		0.76		μC			
I <sub>RM</sub>			8.00		Α			

Note 1: Pulse test,  $t \le 300\mu s$ ; duty cycle,  $d \le 2\%$ .



Fig. 1. Extended Output Characteristics
@ 25°C

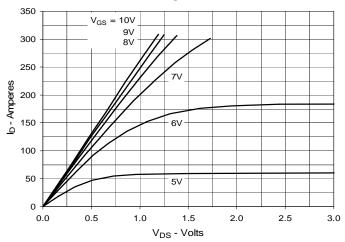


Fig. 3.  $R_{DS(on)}$  Normalized to  $I_D$  = 140A Value

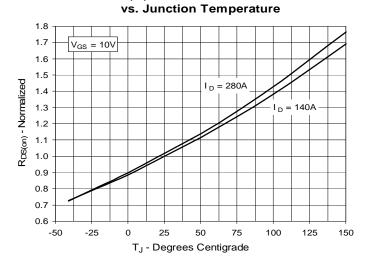


Fig. 5. Maximum Drain Current vs.

Case Temperature

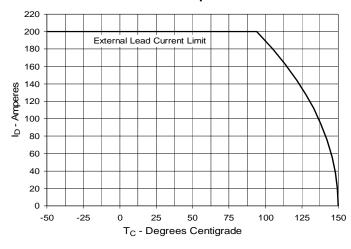


Fig. 2. Output Characteristics @ 125°C

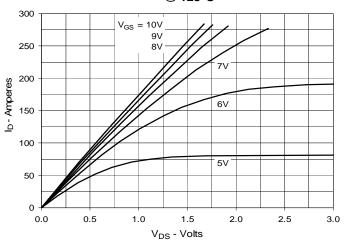


Fig. 4. R<sub>DS(on)</sub> Normalized to I<sub>D</sub> = 140A Value vs. Drain Current

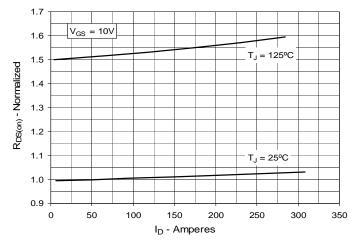
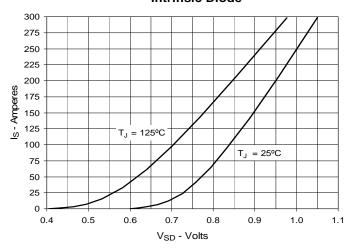
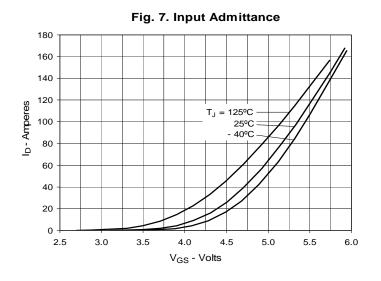
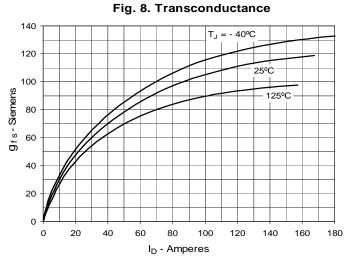


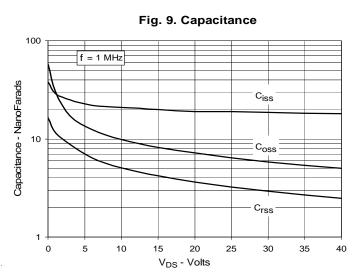
Fig. 6. Forward Voltage Drop of Intrinsic Diode











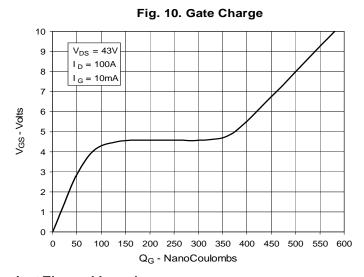
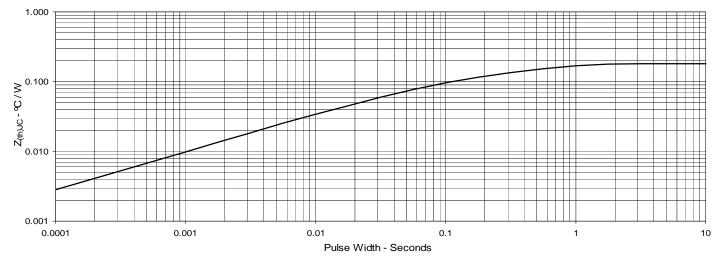


Fig. 11. Maximum Transient Thermal Impedance



IXYS reserves the right to change limits, test conditions, and dimensions.



Fig. 12. Forward-Bias Safe Operating Area  $@T_C = 25^{\circ}C$ 

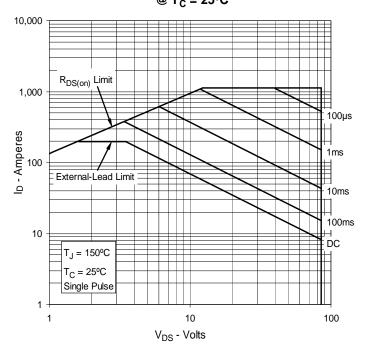


Fig. 13. Forward-Bias Safe Operating Area  $@T_C = 75^{\circ}C$ 

